

INCH-POUND

MIL-PRF-83401/22A
18 March 1996
SUPERSEDING
MIL-PRF-83401/22
13 August 1991

PERFORMANCE SPECIFICATION

RESISTOR NETWORK, FIXED, FILM,
STYLE RZ220, 8 PIN SIP

This specification is approved for use by all Departments
and Agencies of the Department of Defense.

1. SCOPE

1.1 Scope. This specification covers the associated requirements for style RZ220, 8 pin single-in-line package (SIP) resistor networks. This style is available in all characteristics and resistance tolerances. This specification has two product levels, a high reliability, 100 percent burn-in screened "M" part number level and nonburn-in screened part number "C".

1.2 Part or Identifying Number (PIN). Resistor networks covered by this specification will be identified by a PIN which will consist of the basic number of this specification and a coded number. The PIN will be in the following form:

100 percent burn-in screened network ("M" part number)

M8340122

H1002FC

Associated specification number

Coded number

Nonburn-in screened network ("C" part number)

C8340122

H1002FC

Associated specification number

Coded number

The coded number is derived in accordance with MIL-PRF-83401.

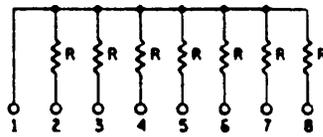
Beneficial comments (recommendations, additions, deletions) and any pertinent data which may be of use in improving this document should be addressed to: Defense Electronics Supply Center, ATTN: DESC-ELDM, 1507 Wilmington Pike, Dayton, OH 45444-5765, by using the Standardization Document Improvement Proposal (DD Form 1426) appearing at the end of this document or by letter.

AMSC N/A

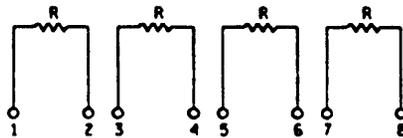
FSC 5905

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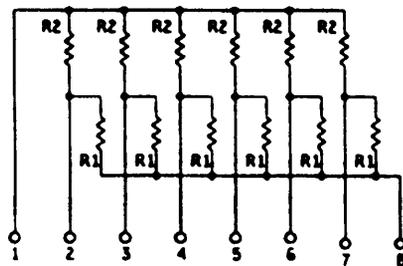
1.2.1 Schematics. The schematic of the resistor network will be identified by a single letter in accordance with the drawings below. The resistor element R_{REF} will be the reference element used in determining the ratio accuracy (when applicable).



SCHMATIC C



SCHMATIC G



SCHMATIC H

1.2.1.1 Standard resistance values. The standard resistance values and the resistance values designators for the H schematic are as specified in table I.

TABLE I. Standard resistance values.

Resistance designator	R_1 (ohms)	R_2 (ohms)	Resistance designator	R_1 (ohms)	R_2 (ohms)
A001	82	130	A010	330	470
A002	120	200	A011	330	680
A003	130	210	A012	1.5k	3.3k
A004	160	260	A013	3.0k	6.2k
A005	180	240	A014	180	270
A006	180	390	A015	270	270
A007	220	270	A016	560	560
A008	220	330	A017	560	1.2k
A009	330	390	A018	620	2.7k

2. APPLICABLE DOCUMENTS

2.1 General. The documents listed in this section are specified in sections 3, 4, and 5 of this specification. The section does not include documents cited in other sections of this specification or recommended for additional information or as samples. While every effort has been made to ensure the completeness of this list, document users are cautioned that they must meet all specified requirements documents cited in sections 3, 4, and 5 of this specification, whether or not they are listed.

2.2 Government documents

2.2.1 Specifications, standards, and handbooks. The following specifications, standards, and handbooks form a part of this document to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation (see 6.2).

SPECIFICATION

DEPARTMENT OF DEFENSE

MIL-PRF-83401 - Resistor Networks, Fixed, Film, and Capacitor-Resistor Networks, Ceramic Capacitor and Fixed Resistors, General Specification for.

(Unless otherwise indicated, copies of the above specifications, standards, and handbooks are available from the Standardization Document Order Desk, Building 4D, 700 Robbins Avenue, Philadelphia, PA 19111-5094.)

2.3 Order of precedence. In the event of a conflict between the text of this document and the references cited herein, the text of this document takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Associated specifications. The individual item requirements shall be in accordance with MIL-PRF-83401, as specified herein.

3.2 Interface and physical dimension. The resistor shall meet the interface and physical dimensions specified on figure 1.

3.2.1 Internal connection. Internal connections shall be accomplished by thermal compression bonding of gold to gold, to form a solid phase weld from the lead to the internal resistor connection. No solder connection, eutectic or noneutectic, shall be permitted in this construction.

3.3 Power rating (70°C). The power ratings for schematics C, G, and H shall be as specified in table II.

TABLE II Power rating

Schematic	Characteristic	Element power rating (watts)	Network power rating (watts)
C	C	0.06	0.42
	H	0.12	0.84
	K	0.12	0.84
	M	0.12	0.84
	V	0.06	0.42
G	C	0.06	0.24
	H	0.12	0.48
	K	0.12	0.48
	M	0.12	0.48
	V	0.06	0.24
H	C	0.04	0.42
	H	0.07	0.84
	K	0.07	0.84
	M	0.07	0.84
	V	0.04	0.42

3.4 Power conditioning. The power applied for power conditioning for schematics C, G, and H shall be 1.5 times rated power.

3.5 Voltage rating. The maximum continuous working voltage for each resistor shall not exceed 50 volts dc or ac rms.

3.6 Resistance. Minimum and maximum resistance values shall be as follows:

Resistance tolerance	Minimum resistance (ohms)	Maximum resistance (megohms)
B (± 0.1 percent)	100.0	0.1
G (± 0.5 percent)	100.0	0.1
F (± 1.0 percent)	10.0	1.0
G (± 2.0 percent)	10.0	1.0
J (± 5.0 percent)	10.0	1.0

4. VERIFICATION

4.1 Sampling and inspection. Sampling and inspection shall be in accordance with MIL-PRF-83401

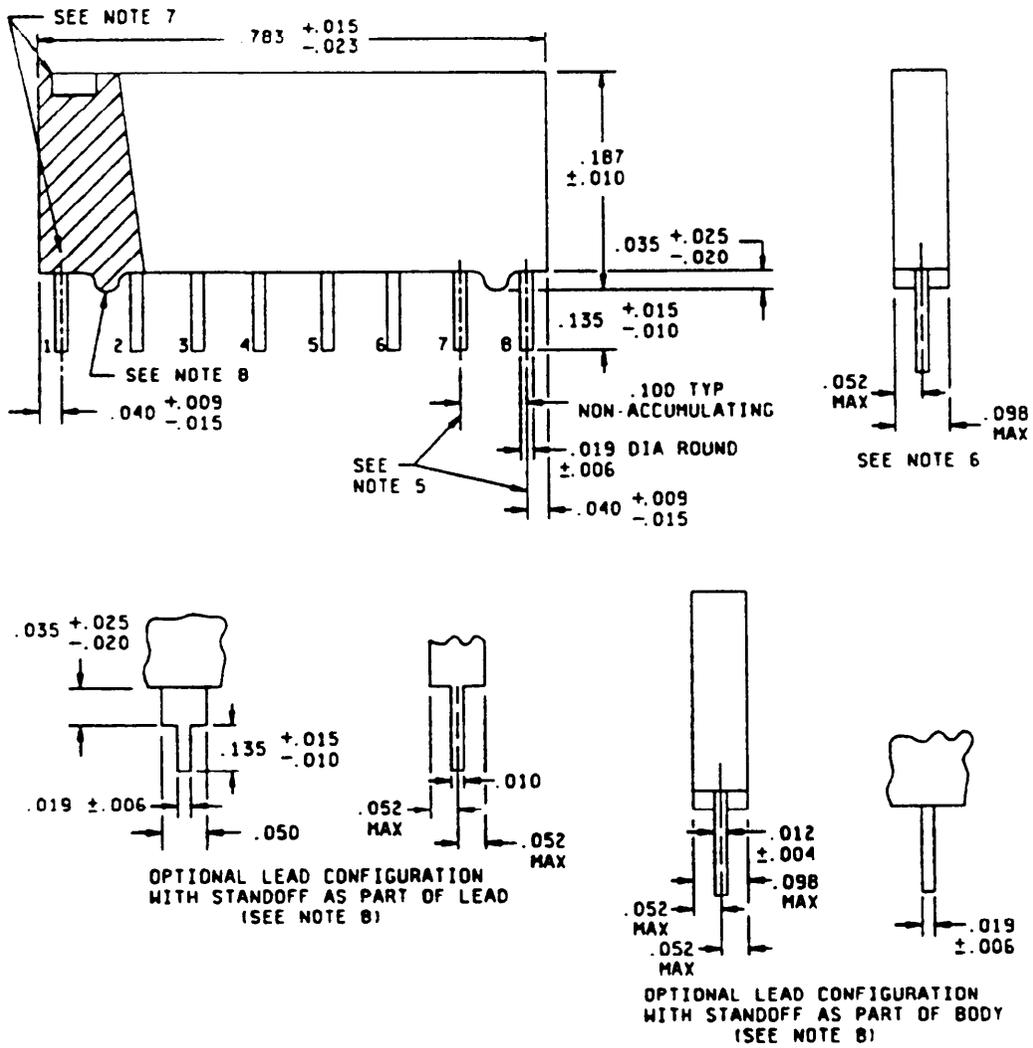


FIGURE 1. Style RZ220 resistors.

Inches	mm	Inches	mm
.004	0.10	.025	0.64
.006	0.15	.035	0.89
.009	0.23	.040	1.02
.010	0.25	.050	1.27
.012	0.30	.052	1.32
.015	0.38	.098	2.49
.019	0.48	.100	2.54
.020	0.51	.135	3.43
.023	0.58	.187	4.76
		.783	19.89

NOTES:

1. Dimensions are inches.
2. Metric equivalents are given for general information only.
3. Unless otherwise specified, tolerances are $\pm .005$ (0.13 mm).
4. The picturization of the styles above is given as representative of the envelope item. Slight deviations from the outline shown, which are contained within the envelope and do not alter the functional aspects of the device, are acceptable.
5. Terminal centerline to centerline measurements made at point of emergence of the lead from the body.
6. Measurement made at the point of emergence of the lead of the body.
7. Pin 1 locator shall be a dot, notch, stripe, or numeral 1 adjacent to pin no. 1, in the shaded area; also, additional marking may be placed on top edge where the bevel may be located.
8. If the standoffs are located on the body, a minimum of two standoffs are required as illustrated. As an option, additional standoffs may be located on the body of the resistor network. If leads with standoffs are used, standoffs on the body are not required.

FIGURE 1 Style RZ220 resistors - Continued

4.2 H schematic tests. For the tests on H schematic, the dc resistance measurements, resistance temperature characteristic measurement, and short time overload power application shall be made between each terminal and the applicable common terminal without compensation for the shunt circuits. The pin to pin dc resistance measurements shall be used directly to determine the acceptability to section 3 requirements.

5. PACKAGING

5.1 Packaging requirements. For acquisition purposes, the packaging requirements shall be as specified in the contract or order (see 6.2). When actual packaging of material is to be performed by DoD personnel these personnel need to contact the responsible packaging activity to ascertain requisite packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activity within the Military Department or Defense Agency, or within the Military Department's System Command. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

6. NOTES

(This section contains information of general or explanatory nature that may be helpful, but is not mandatory.)

6.1 Notes. The notes specified in MIL-PRF-83401 are applicable to this specification.

6.2 Acquisition requirements. Acquisition documents must specify the following:

- a. Title, number, and date of this specification, and the complete PIN (see 1.2).
- b. Issue of DoDISS to be cited in the solicitation, and if required, the specific issue of individual documents referenced (see 2.1).

6.3 Changes from previous issue. Marginal notations are not used in this revision to identify changes with respect to the previous issue due to the extent of the changes.

CONCLUDING MATERIAL

Custodians:

Army - ER
Navy - EC
Air Force - 85
NASA - NA

Preparing activity:

DLA - ES

(Project 5905-1450-17)

Review activities:

Army - AR, AT, AV, ME, MI
Navy - AS, CG, MC, OS
Air Force - 17, 19

